

EN5322QI

2 A Voltage Mode Synchronous Buck PWM DC-DC Converter with Integrated Inductor

> RoHS Compliant Halogen Free

## **General Description**

The EN5322 is a high efficiency synchronous buck converter with integrated inductor, PWM controller, MOSFETS, and compensation providing the smallest possible solution size.

The 4 MHz operation allows for the use of tiny MLCC capacitors. It also enables a very wide control loop bandwidth providing excellent transient performance and reduced output impedance. The internal compensation is designed for unconditional stability across all operating conditions.

Three VID output voltage select pins provide seven pre-programmed output voltages along with an option for external resistor divider. Output voltage can be programmed on-the-fly to provide fast, dynamic voltage scaling with smooth transitions between VID programmed output voltages.

# **Applications**

- Point of Load Regulation for Low Power Processors, Network Processors, DSPs' FPGAs and ASICs
- Replacement of LDOs
- Noise Sensitive Applications such as A/V and RF
- Computing, Computer Peripherals, Storage, Networking, and Instrumentation
- DSL, STB, DVR, DTV, and iPC

## **Ordering Information**

Part Number	Temp Rating (°C)	Package	
EN5322QI-T	-40 to +85	24-pin QFN T&R	
EN5322QI-E	QFN Evaluation Board		

#### March 2008

## Features

- Revolutionary Integrated Inductor
- Total Solution Footprint as Small as 50 mm<sup>2</sup>
- 4 mm x 6 mm x 1.1 mm QFN Package
- 4 MHz Fixed Switching Frequency
- High Efficiency, up to 95 %
- Low Ripple Voltage; 8 mV<sub>P-P</sub> Typical
- 2% Initial VOUT Accuracy with VID Codes
- 2% Initial 0.6 V Feedback Voltage Accuracy
- 2.4 V to 5.5 V Input Voltage Range
- 2 A Continuous Output Current Capability
- Fast Transient Response
- Low Dropout Operation: 100 % Duty Cycle
- Power OK Signal with 5 mA Sink Capability
- Dynamic Voltage Scaling with VID Codes
- 17 µA Typical Shutdown Current
- Under Voltage Lockout, Over Current, Short Circuit, and Thermal Protection
- RoHS Compliant; MSL 3 260 °C Reflow

# **Application Circuit**

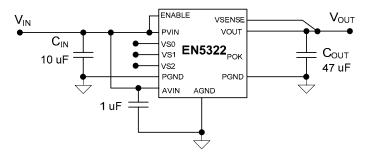


Figure 1. Typical Application Circuit

# **Absolute Maximum Ratings**

**CAUTION**: Absolute maximum ratings are stress ratings only. Functional operation beyond recommended operating conditions is not implied. Stress beyond absolute maximum ratings may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

Absolute Maximum Electrical Ratings	MIN	MAX
Voltages on: PVIN, AVIN, VOUT	-0.3 V	6.5 V
Voltages on: VSENSE, VS0, VS1, VS2, ENABLE, POK	-0.3 V	V <sub>IN</sub>
Voltage on: VFB	-0.3 V	2.7 V
ESD Rating (Human Body Model)	2 kV	
ESD Rating (Charge Device Model)	500 V	
Absolute Maximum Thermal Ratings		
Ambient Operating Range	-40 °C	+85 °C
Storage Temperature Range	-65 °C	+150 °C
Reflow Peak Body Temperature MSL3 (10 s)		+260 °C

# Thermal Characteristics

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS
Thermal Shutdown	T <sub>SD</sub>		155		°C
Thermal Shutdown Hysteresis	T <sub>SDH</sub>		15		°C
Thermal Resistance: Junction to Case (0 LFM)	$\theta_{JC}$		6		°C/W
Thermal Resistance: Junction to Ambient (0 LFM)*	θ <sub>JA</sub>		36		°C/W

\* Based on a 2 oz. copper board and proper thermal design in line with JEDEC EIJ-JESD51 standards

#### **Recommended Operating Conditions**

PARAMETER	SYMBOL	MIN	MAX	UNITS
Input Voltage Range	V <sub>IN</sub>	2.4	5.5	V
Output Voltage Range	V <sub>OUT</sub>	0.6	V <sub>IN</sub> - V <sub>DROPOUT</sub>	V
Output Current	I <sub>LOAD</sub>	0	2	А
Operating Junction Temperature	TJ	-45	+125	С°

Note:  $V_{DROPOUT}$  is defined as (I<sub>LOAD</sub> x Dropout Resistance) including temperature effect.

# **Electrical Characteristics**

 $V_{IN} = 5 \text{ V}$  and  $T_A = 25 \text{ °C}$ , unless otherwise noted.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Operating Input Voltage	V <sub>IN</sub>		2.4		5.5	V
Under Voltage Lockout	V <sub>UVLO</sub>	V <sub>IN</sub> going low to high		2.2		V
UVLO Hysteresis				0.15		V
Output Voltage with VID Codes (Note 1)	V <sub>OUT</sub>	$\begin{array}{c} T_{A} = 25 \ ^{\circ}C; \ V_{IN} = 5V \\ I_{LOAD} = 100 \ mA \\ \hline \underline{VS2 \ VS1 \ VS0 \ VOUT \ (V)} \\ \hline 0  0  0  3.3 \\ 0  0  1  2.5 \\ 0  1  0  1.8 \\ 0  1  1  1.5 \\ 1  0  0  1.25 \\ 1  0  1  1.2 \\ 1  1  0  0.8 \end{array}$	-2.0 -2.0 -2.0 -2.0 -2.0 -2.0 -2.0		+2.0 +2.0 +2.0 +2.0 +2.0 +2.0 +2.0	%
VFB Voltage	$V_{FB}$	T <sub>A</sub> = 25 °C; V <sub>IN</sub> = 5V	0.588	0.600	0.612	V

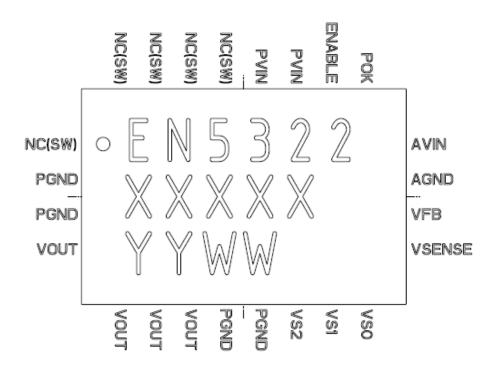
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March 2008

March 2008						N5322G
PARAMETER	SYMBOL		MIN	TYP	MAX	UNITS
		$I_{LOAD} = 100 \text{ mA}, \text{ VS0} = \text{VS1} = \text{VS2} = 1$				
Output Voltage with VID Codes (Note 1)	V <sub>out</sub>	$\begin{array}{c} 2.4 \ V \leq V_{\text{IN}} \leq 5.5 \ V, \ I_{\text{LOAD}} = 0 \ \sim 2 \ \text{A}, \\ -40^{\circ}\text{C} \leq T_{\text{A}} \leq +85^{\circ}\text{C} \\ \hline \underline{VS2 \ VS1 \ VS0 \ VOUT \ (V)} \\ \hline 0  0  0  3.3 \\ 0  0  1  2.5 \\ 0  1  0  1.8 \\ 0  1  1  1.5 \\ 1  0  0  1.25 \\ 1  0  0  1.25 \\ 1  0  1  1.2 \\ 1  1  0  0.8 \end{array}$	-3.0 -3.0 -3.0 -3.0 -3.0 -3.0 -3.5		+3.0 +3.0 +3.0 +3.0 +3.0 +3.0 +3.0	%
VFB Voltage	$V_{FB}$	$\begin{array}{l} 2.4 \; V \leq V_{IN} \leq 5.5 \; V, \; I_{LOAD} = 0 \; \sim 2 \; A, \\ VS0 = VS1 = VS2 = 1, \\ -40^{\circ}C \leq T_A \leq +85^{\circ}C \end{array}$	0.582	0.600	0.618	V
Dynamic Voltage Slew Rate			0.975	1.5	2.025	V/ms
Soft Start Slew Rate			0.975	1.5	2.025	V/ms
VFB, ENABLE, VS0-VS2 Pin Input Current (Note 2)		$\text{-40°C} \leq T_A \leq \text{+85°C}$			+/-40	nA
ENABLE, VS0-VS2 Voltage Threshold		Logic Low Logic High	0.0 1.4		0.4 V <sub>IN</sub>	V
POK Upper Threshold		V <sub>OUT</sub> Rising		111		%
POK Upper Threshold		V <sub>OUT</sub> Falling		102		%
POK Lower Threshold		V <sub>OUT</sub> Rising		92		%
POK Lower Threshold		V <sub>out</sub> Falling		90		%
POK Low Voltage		$I_{SINK}$ = 5 mA, -40°C $\leq$ T <sub>A</sub> $\leq$ +85°C		0.15	0.4	V
POK Pin V <sub>OH</sub> Leakage Current		POK High, -40°C $\leq$ T <sub>A</sub> $\leq$ +85°C			500	nA
Shutdown Current		ENABLE Low		17		μA
Quiescent Current		No Switching		800		μA
Quiescent Current		Switching, V <sub>OUT</sub> = 1.2 V		15		mA
Current Limit Threshold		$2.4 \text{ V} \le V_{\text{IN}} \le 5.5 \text{ V},$ -40°C $\le T_{\text{A}} \le +85$ °C	2.1	3.0		А
PFET On Resistance				160		mΩ
NFET On Resistance				60		mΩ
Dropout Resistance				200	300	mΩ
Operating Frequency	Fosc			4		MHz
Output Ripple Voltage		$C_{OUT} = 1 x 47 \mu F 1206 X5R MLCC,$ $V_{OUT} = 1.2 V, I_{LOAD} = 2 A$		14		$mV_{P-P}$
Output Ripple Voltage	V <sub>RIPPLE</sub>	$C_{OUT} = 2 \times 22 \ \mu F \ 0805 \ X5R \ MLCC,$ $V_{OUT} = 1.2 \ V, \ I_{LOAD} = 2 \ A$		8		$mV_{P-P}$

Note 1: The tolerances hold true only if  $V_{IN}$  is greater than ( $V_{OUT} + V_{DROPOUT}$ ). Note 2: VFB, ENABLE, VS0-VS2 pin input current specification is guaranteed by design.

# Pin Configuration



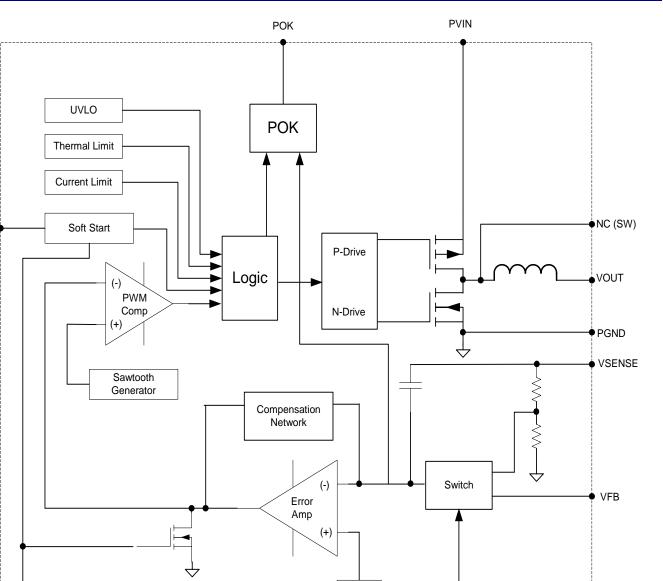
#### Figure 2. Pin Diagram, Top View.

# **Pin Description**

PIN	NAME	FUNCTION
1, 21-24	NC(SW)	No Connect. These pins are internally connected to the common drain output of the internal MOSFETs. NC(SW) pins are not to be electrically connected to any external signal, ground, or voltage. However, they must be soldered to the PCB. Failure to follow this guideline may result in part malfunction or damage.
2-3, 8-9	PGND	Input/Output Power Ground. Connect these pins to the ground electrode of the input and output filter capacitors. Refer to Layout Considerations section for details.
4-7	VOUT	Voltage and Power Output. Connect these pins to output capacitor(s).
10-12	VS2-0	Output Voltage Select. These pins set one of seven preset output voltages and the external divider option (refer to Electrical Characteristics table for more details), and can be directly pulled up to $V_{IN}$ or pulled down to GND; these pins must not be left floating.
13	VSENSE	Sense Pin for Internally Programmed Output Voltages with VID Codes. For either VID code or external resistor divider applications, connect this pin to the last local output filter capacitor for internal compensation.
14	VFB	Feedback Pin for External Voltage Divider Network. Connect a resistor divider to this pin to set the output voltage. Use 340 k $\Omega$ , 1% or better for the upper resistor.
15	AGND	Analog Ground for the Controller Circuits
16	AVIN	Analog Voltage Input for the Controller Circuits. Connect this pin to the input power supply. Use a 1 $\mu$ F bypass capacitor on this pin.
17	POK	Power OK with an Open Drain Output. Refer to Power OK section.
18	ENABLE	Input Enable. A logic high signal on this pin enables the output and initiates a soft start. A logic low signal disables the output and discharges the output to GND. This pin must not be left floating.
19-20	PVIN	Input Power Supply. Connect to input supply. Decouple with input capacitor(s) to PGND.

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ENABLE



DAC

Voltage

Select

VS0 VS1 VS2

Package Boundary

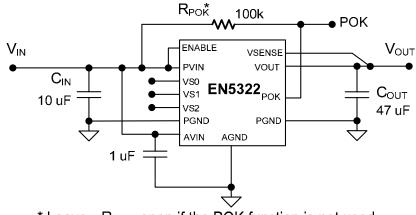


VREF

BIAS

AGND

AVIN



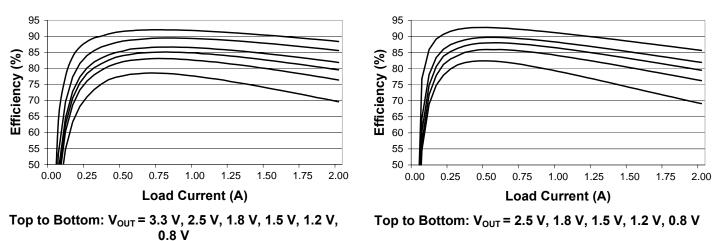
\* Leave  $R_{POK}$  open if the POK function is not used.

#### Figure 4. Typical Application Circuit with VID Codes.

(NOTE: Enable can be separated from PVIN if the application requires it)

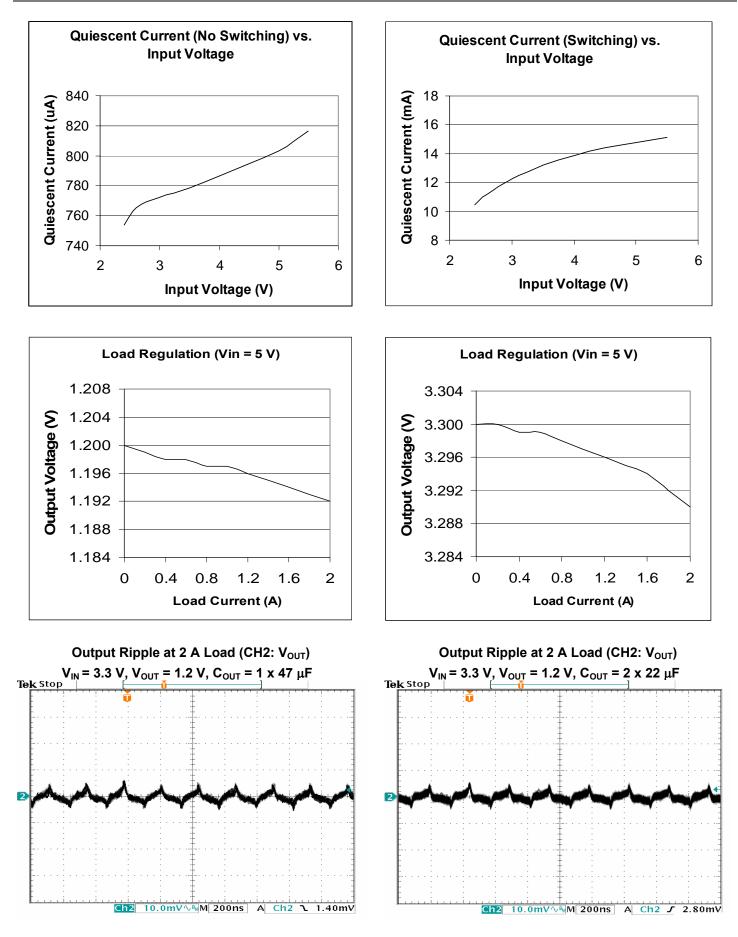
## **Typical Performance Characteristics**

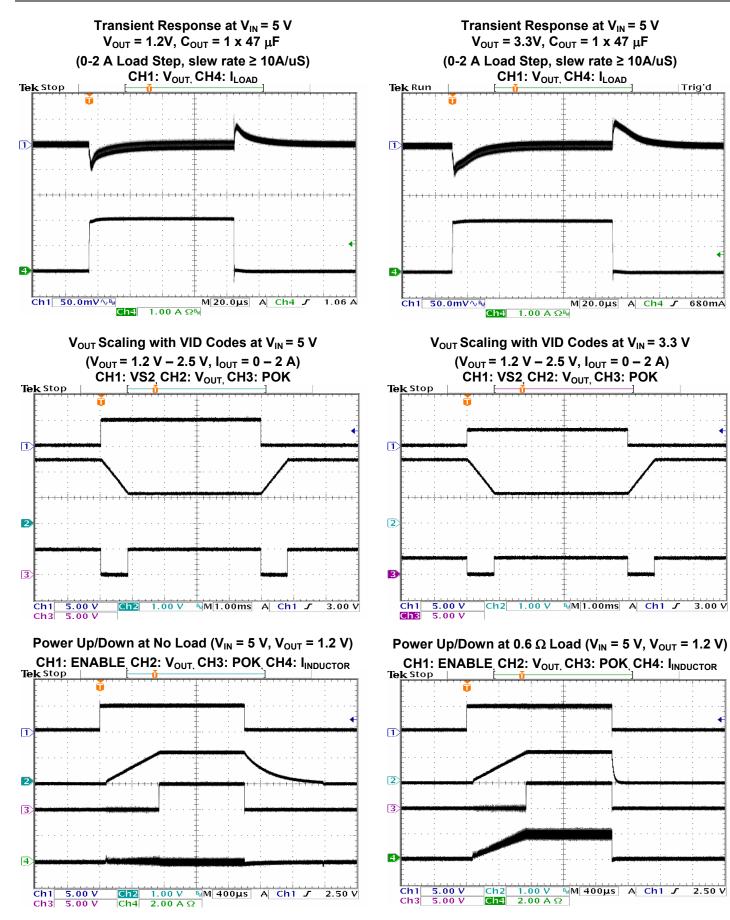
Circuit of Figure 4,  $V_{IN} = 5 V$ ,  $V_{OUT} = 1.2 V$  and  $T_A = 25^{\circ}C$ , unless otherwise noted.

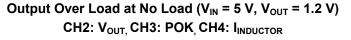


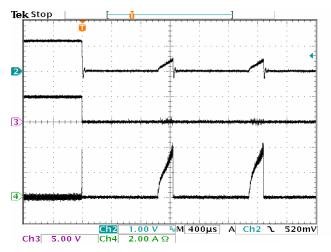
#### Efficiency vs. Load Current (Vin = 5.0V)

Efficiency vs. Load Current (Vin = 3.3V)

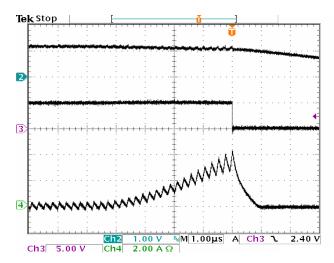








Output Over Load at No Load (V<sub>IN</sub> = 5 V, V<sub>OUT</sub> = 1.2 V) CH2: V<sub>OUT</sub>, CH3: POK, CH4: I<sub>INDUCTOR</sub>

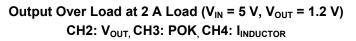


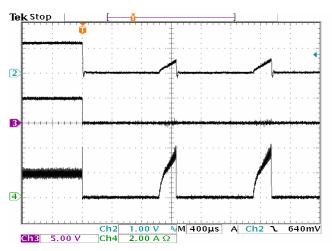
## **Functional Description**

The EN5322 leverages advanced CMOS technology to provide high switching frequency, while also maintaining high efficiency.

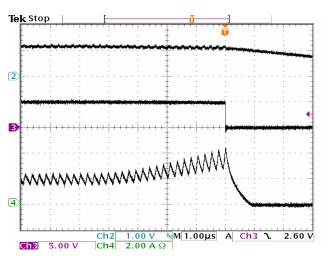
Packaged in a 4 mm x 6 mm x 1.1 mm QFN, the EN5322 provides a high degree of flexibility in circuit design while maintaining a very small footprint. High switching frequency allows for the use of very small MLCC input and output filter capacitors.

The converter uses voltage mode control to provide high noise immunity, low output





Output Over Load at 2 A Load (V<sub>IN</sub> = 5 V, V<sub>OUT</sub> = 1.2 V) CH2: V<sub>OUT</sub>, CH3: POK, CH4: I<sub>INDUCTOR</sub>



impedance and excellent load transient response. No external compensation components are needed for most applications.

Output voltage is chosen from one of seven preset values via a three-pin VID voltage select scheme. An external divider option enables the selection of any output voltage  $\geq 0.6$  V. The VID pins can be toggled dynamically to implement glitch-free dynamic voltage scaling between any two VID preset values.

POK monitors the output voltage and signals if it is within  $\pm 10\%$  of nominal. Protection

features include under voltage lockout (UVLO), over current protection, short circuit protection, and thermal overload protection.

# Stability over Wide Range of Operating Conditions

The EN5322 utilizes an internal compensation network and is designed to provide stable operation over a wide range of operating conditions. To improve transient performance or reduce output voltage ripple with dynamic the loads you have option to add supplementary capacitance to the output. The EN5322 is stable with up to 60  $\mu$ F of output capacitance without compensation adjustment. Additional output capacitance above 60 µF can accommodated compensation be with adjustment depending on the application. The high switching frequency allows for a wide control loop bandwidth.

## Soft Start

The internal soft start circuit limits inrush current when the device starts up from a power down condition or when the ENABLE pin is asserted "high". Digital control circuitry sets the  $V_{OUT}$  ramp rate to minimize input voltage ripple and inrush current to ensure a glitch-free start up. The soft start ramp rate is nominally 1.5 V/ms.

## **Over Current/Short Circuit Protection**

When an over current condition occurs,  $V_{OUT}$  is pulled low. This condition is maintained for a period of 1.2 ms and then a normal soft start cycle is initiated. If the over current condition still persists, this cycle will repeat.

## **Under Voltage Lockout**

An under voltage lockout circuit will hold off switching during initial power up until the input voltage reaches sufficient level to ensure proper operation. If the voltage drops below the UVLO threshold the lockout circuitry will again disable switching. Hysteresis is included to prevent chattering between UVLO high and low states.

#### Enable

The ENABLE pin provides means to shut down the converter or initiate normal operation. A logic high will enable the converter to go through the soft start cycle and regulate the output voltage to the desired value. A logic low will allow the device to discharge the output and go into shutdown mode for minimal power consumption. When the output is discharged, an auxiliary NFET turns on and limits the discharge current to 300 mA or below. In shutdown mode, the device typically drains  $17\mu$ A. The ENABLE pin must not be left floating.

## Thermal Shutdown

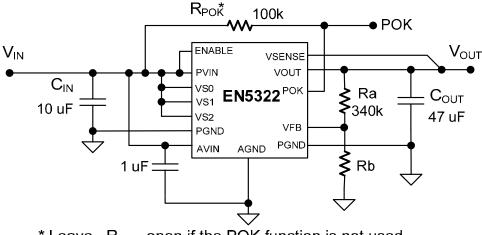
When excessive power is dissipated in the device, its junction temperature rises. Once the junction temperature exceeds the thermal shutdown temperature 155 °C, the thermal shutdown circuit turns off the converter, allowing the device to cool. When the junction temperature drops 15 °C, the device will be reenabled and go through a normal startup process.

## Power OK

The EN5322 provides an open drain output to indicate if the output voltage stays within 92% to 111% of the set value. Within this range, the POK output is allowed to be pulled high. Outside this range, POK remains low. However, during transitions such as power up, power down, and dynamic voltage scaling, the POK output will not change state until the transition is complete for enhanced noise immunity.

The POK has 5 mA sink capability for events where it needs to feed a digital controller with standard CMOS inputs. When POK is pulled high, the pin leakage current is as low as 500 nA maximum over temperature. This allows a large pull up resistor such as 100 k $\Omega$  to be used for minimal current consumption in shutdown mode.

The POK output can also be conveniently used as an ENABLE input of the next stage for power sequencing of multiple converters.



\* Leave  $R_{POK}$  open if the POK function is not used.

**Figure 5. Typical Application Circuit with External Resistor Divider.** (*NOTE:* Enable can be separated from PVIN if the application requires it)

## **Application Information**

#### Setting the Output Voltage

To provide the highest degree of flexibility in choosing output voltage, the EN5322QI uses a 3 pin VID (Voltage ID) output voltage select arrangement. This allows the designer to choose one of seven preset voltages, or to use an external voltage divider. Figure 4 shows a typical application circuit with VID codes. Internally, the output of the VID multiplexer sets the value for the voltage reference DAC, which in turn is connected to the non-inverting input of the error amplifier. This allows the use of a single feedback divider with constant loop gain and optimum compensation, independent of the output voltage selected.

Table 1 shows the various VS0-VS2 pin logic states and the associated output voltage levels. A logic "1" indicates a connection to V<sub>IN</sub> or to a "high" logic voltage level. A logic "0" indicates a connection to ground or to a "low" logic voltage level. These pins can be either hardwired to V<sub>IN</sub> or GND or alternatively can be driven by standard logic levels. Logic low is defined as  $V_{LOW} \le 0.4V$ . Logic high is defined as  $V_{HIGH} \ge 1.4V$ . Any level between these two

values is indeterminate. These pins must not be left floating.

Table 1. VID voltage select settings.

VS2	VS1	VS0	V <sub>OUT</sub>
0	0	0	3.3V
0	0	1	2.5V
0	1	0	1.8V
0	1	1	1.5V
1	0	0	1.25V
1	0	1	1.2V
1	1	0	0.8V
1	1	1	User
			Selectable

## **External Voltage Divider**

As described above, the external voltage divider option is chosen by connecting the VS0, VS1, and VS2 pins to VIN or logic "high". The EN5322QI uses a separate feedback pin,  $V_{FB}$ , when using the external divider. VSENSE must be connected to  $V_{OUT}$  as indicated in Figure 5.

If the external voltage divider option is chosen, use 340 k $\Omega$ , 1% or better for the upper resistor Ra. Then the value of the bottom resistor Rb in k $\Omega$  is given as:

$$Rb = \frac{204}{V_{OUT} - 0.6} k\Omega$$

Where  $V_{OUT}$  is the output voltage. Rb should also be a 1% or better resistor.

# Input and Output Capacitor Selection

Low ESR MLC capacitors with X5R or X7R or equivalent dielectric should be used for input and output capacitors. Y5V or equivalent dielectrics lose too much capacitance with frequency, DC bias, and temperature. Therefore, they are not suitable for switchmode DC-DC converter filtering, and must be avoided.

A 10  $\mu$ F, 10 V, 0805 MLC capacitor is needed on PVIN for all applications. A 1  $\mu$ F, 10 V, 0402 MLC capacitor on AVIN is needed for high frequency bypass to ensure clean chip supply for optimal performance.

A 47  $\mu$ F, 6.3 V, 1206 MLC capacitor is recommended on the output for most applications. The output ripple can be reduced by approximately 50% by using 2 x 22  $\mu$ F, 6.3V, 0805 MLC capacitors rather than 1 x 47  $\mu$ F.

C <sub>IN</sub>	<b>Description</b>	<b>Mfg.</b>	<b>P/N</b>
	10μF, 10V,	Taiyo Yuden	LMK212BJ106KG
	X5R, 10%,	Murata	GRM21BR71A106KE51L
	0805	Panasonic	ECJ-2FB1A106K
C <sub>OUT</sub>	47μF, 6.3V,	Taiyo Yuden	JMK316BJ476ML
	X5R, 20%,	Murata	GRM31CR60J476ME19L
	1206	Kemet	C1206C476M9PACTU

#### Table 2. Recommended input and output capacitors

# POK Pull Up Resistor Selection

POK can be pulled up through a resistor to any voltage source as high as  $V_{IN}$ . The simplest way is to connect POK to the power input of the converter through a resistor. A 100 k $\Omega$  pull up resistor is typically recommended for most

applications for minimal current drain from the voltage source and good noise immunity. POK can sink up to 5mA.

## Layout Considerations

Proper layout and placement of external components is critical to optimal functioning of the converter and for minimizing radiated and conducted noise.

Follow these layout guidelines as demonstrated on the EN5322 customer eval boards:

- 1. Input and output capacitors should be placed on the same side of the PCB as the EN5322 and immediately adjacent to their respective pins on the package. To minimize parasitic inductances, the traces for making these connections should be as short and wide as possible.
- 2. A row of vias connecting these capacitors' ground pads to the PCB GND plane should be placed along the edge of the capacitor ground copper closest to the positive capacitor pads. These vias should start as close to the device as possible and continue underneath the capacitors.
- Avoid adding a test pin or test pad for NC(SW) pins on the PCB. Doing so can compromise the GND plane and result in degradation of the performance.
- 4. There should be as many vias as possible connecting the thermal pad under the device to the PCB GND plane for best thermal performance. Ideally, the vias should have a drill diameter of 0.33 mm (10 mils) with at least 1 oz copper plating in the barrel.
- Keep the input and output current loops separate from each other as much as possible. Keep sensitive signals on the PCB away from the power supply circuit.
- 6. Connect the VSENSE trace to the last local output capacitor. Make sure the trace inductance between the output capacitors and the sensing point is minimized. The VSENSE trace should also be kept away from noisy signals that can contaminate it.

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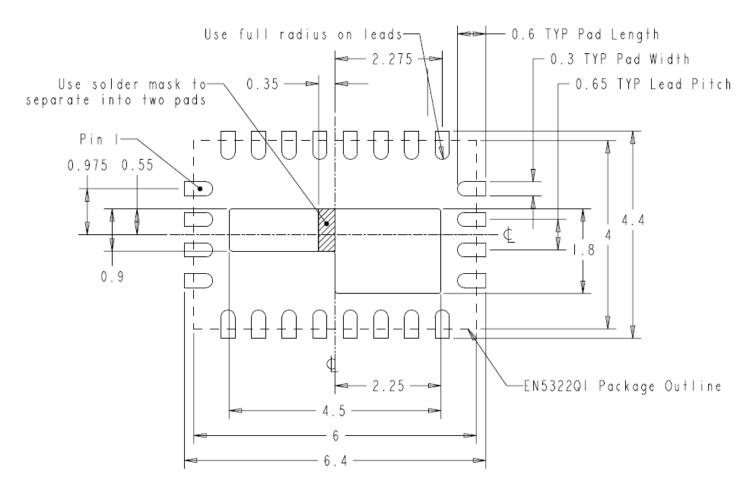
- 7. When using multiple converters on the same PCB, try to minimize any crosstalk between them:
  - Keep the input circuit of any converter away from the output circuit of any other converter.
  - Isolate the input circuits from each other by connecting all the inputs to a common point using a star connection. Add a 2.2 μF bypass capacitor to the GND plane at the star connection. Some applications may benefit from an SMT ferrite bead between the input capacitor of each converter and the star connection point.

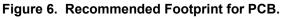
# **Design Considerations for Lead-Frame Based Modules**

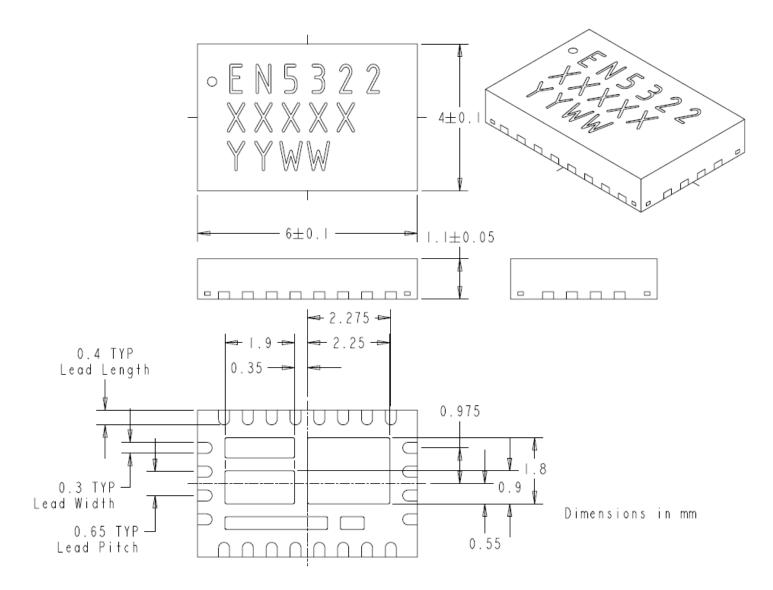
#### **Exposed Metal Pads on Package Bottom**

QFN lead-frame based package technology utilizes exposed metal pads on the bottom of the package that provide improved thermal dissipation and low package thermal resistance, smaller package footprint and thickness, large lead size and pitch, and excellent lead co-planarity. As the EN5322 package is a fully integrated module consisting of multiple internal devices, the lead-frame provides circuit interconnection and mechanical support of these devices resulting in multiple exposed metal pads on the package bottom.

Only the two large thermal pads and the perimeter leads are to be mechanically/electrically connected to the PCB through a SMT soldering process. All other exposed metal is to remain free of any interconnection to the PCB. Figure 6 shows the recommended PCB metal layout for the EN5322 package. A GND pad with a solder mask "bridge" to separate into two pads and 24 signal pads are to be used to match the metal on the package. The PCB should be clear of any other metal, including traces, vias, etc., under the package to avoid electrical shorting.







#### Additional Products

Part Number	Description
EP5352QI	500 mA dc-dc with integrated inductor; 5 mm x 4 mm x 1.1 mm package
EP5362QI	600 mA dc-dc with integrated inductor; 5 mm x 4 mm x 1.1 mm package
EP5382QI	800 mA dc-dc with integrated inductor; 5 mm x 4 mm x 1.1 mm package
EP5368QI	600 mA dc-dc with integrated inductor; 3 mm x 3 mm x 1.1 mm package
EN5311QI	1 A dc-dc with integrated inductor; 5 mm x 4 mm x 1.1 mm package
EN5335QI	3 A dc-dc with integrated inductor; 10 mm x 7.5 mm x 1.85 mm QFN package
	3-Pin VID V <sub>OUT</sub> programming
EN5336QI	3 A dc-dc with integrated inductor; 10 mm x 7.5 mm x 1.85 mm QFN package
	External resistor divider V <sub>OUT</sub> programming
EN5365QI	6 A dc-dc with integrated inductor; 12 mm x 10 mm x 1.85 mm QFN package
ENSSOU	3-Pin VID V <sub>OUT</sub> programming; Parallel capable
EN5366QI	6 A dc-dc with integrated inductor; 12 mm x 10 mm x 1.85 mm QFN package
	External resistor divider V <sub>OUT</sub> programming; Parallel capable

# **Contact Information**

Enpirion, Inc. 685 Route 202/206 Suite 305 Bridgewater, NJ 08807 Phone: 908-575-7550 Fax: 908-575-0775

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